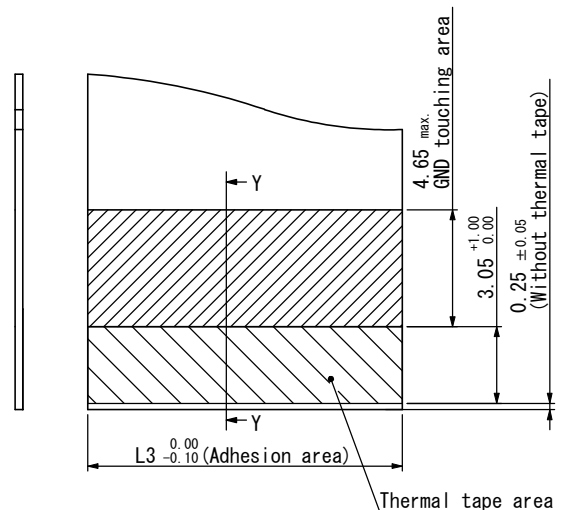
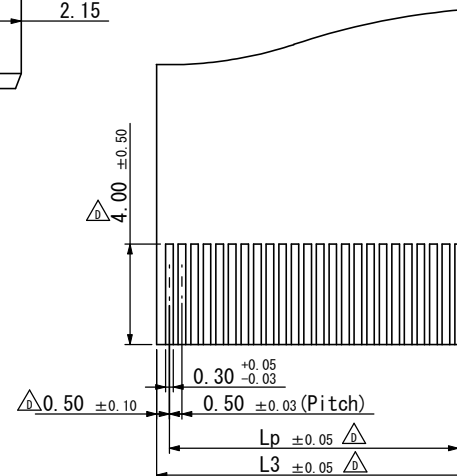
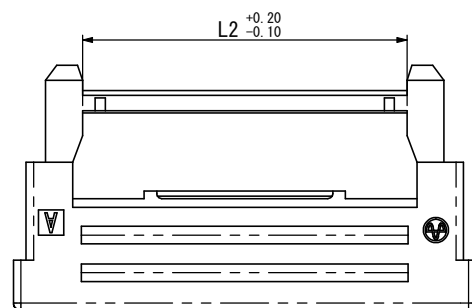
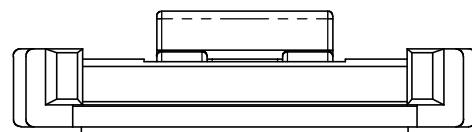
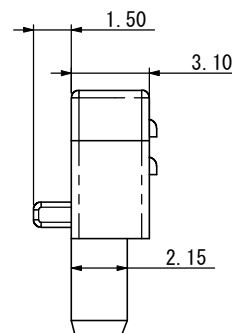
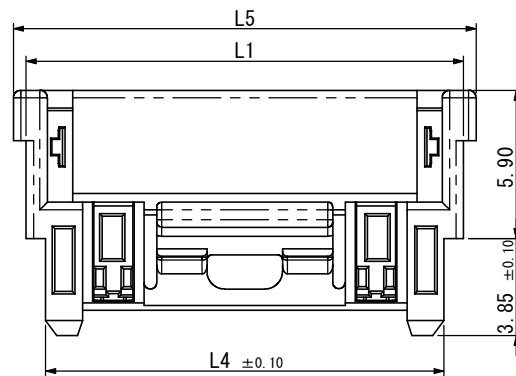
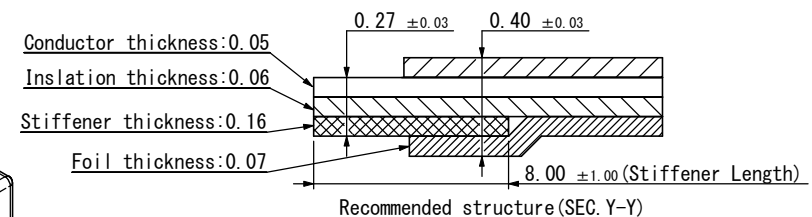


	REVISION DESCRIPTION	APP.	DRW.	DATE	CHANGE NO.
△ x 9	Tolerance change	0. S	0. S	13/08/15	
△ x 2	Change thermal tape area	0. S	0. S	13/10/24	
△ x 9	Tolerance change	0. S	0. S	14/12/02	DC14-0070

50	24.5	30.4	25.9	△ 25.5	28.85	31.4	CNU018P-050-0001
32	15.5	21.4	16.9	△ 16.5	19.85	22.4	CNU018P-032-0001
24	11.5	17.4	12.9	△ 12.5	15.85	18.4	CNU018P-024-0001
Pin count	Lp	L1	L2	L3	L4	L5	P/N



PAD plating SPEC: Au 0.10 μmMIN.
(Over Ni 1.0 μmMIN.)



1	Insulator	1	Plastic	Black
ITEM No.	DESCRIPTION	QNT.	MATERIAL	CONTENT

Note.

1. This product is an adaptor. Assembly with FFC and metal shell cover is required.
After that it becomes a final product.

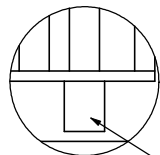
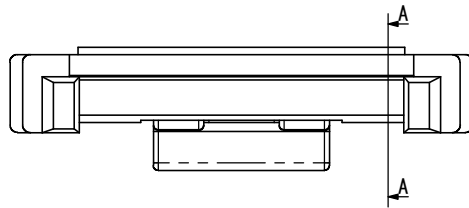
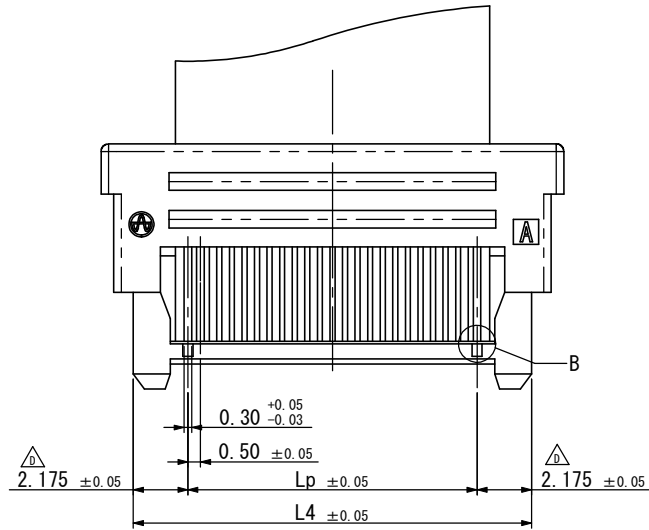
2. Recommended adhesive

Adapter must be glued to the FFC cable with Dexerial 3410 thermal tape.

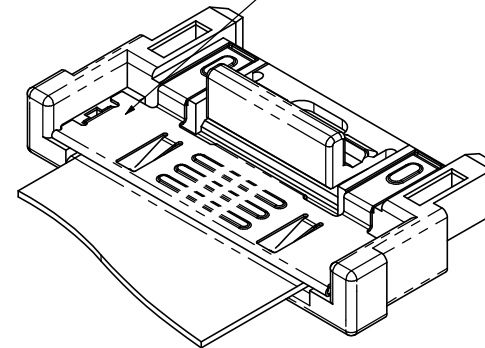
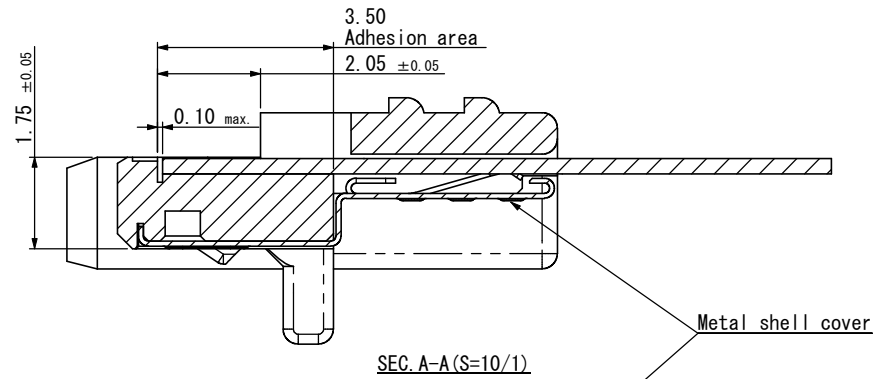
Tolerance ±0.25 Unless otherwise specified.						YAMAICHI ELECTRONICS USA INC.	
CLASS						TITLE	
SCALE	5/1	APP.	APP.	CHK.	DRW.	DSGN.	CNU018P-xxx-0001
DIMENTION	mm	12/09/25	12/09/25	12/09/25	12/09/25	12/09/25	
ANGLE PROJ	3rd	K. Abe	K. Abe	O. Shimizu	O. Shimizu	O. Shimizu	
DRW No.						YEU-A2014	REV.
						1/2	D

Location dimension in which cable is installed(FEF.)

Option 1



Alignment mark for cable
(PAD must be located within mark)
DETAIL B(S=20/1)



Tolerance ±0.25 Unless otherwise specified.						YAMAICHI ELECTRONICS USA INC.	
						CLASS	
SCALE	5/1	APP.	APP.	CHK.	DRW.	DSGN.	TITLE
DIMENSION	mm	12/09/25	12/09/25	12/09/25	12/09/25	12/09/25	CNU018P-xxx-0001
ANGLE PROJ	3rd	K. Abe	K. Abe	O. Shimizu	O. Shimizu		DRW No. YEU-A2014
						Sheet No. 2/2	REV. D